Power Products Division

Advance Information

SELF-OSCILLATING HALF-BRIDGE DRIVER

The MPIC2151 is a high voltage, high speed, self–oscillating power MOSFET and IGBT driver with both high side and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The front–end features a programmable oscillator which is similar to the 555 timer. The output drivers feature a high pulse current buffer stage and an internal deadtime designed for minimum driver cross–conduction. Propagation delays for the two channels are matched to simplify use in 50% duty cycle applications. The floating channel can be used to drive an N–channel power MOSFET or IGBT in the high side configuration that operates off a high voltage rail from 10 to 600 volts.

- Floating Channel Designed for Bootstrap Operation
- Fully Operational to +600 V
- Tolerant to Negative Transient Voltage
- dV/dt Immune
- Undervoltage Lockout
- Programmable Oscillator Frequency:

$$f = \frac{1}{1.4 \text{ (RT + 75\Omega) CT}}$$

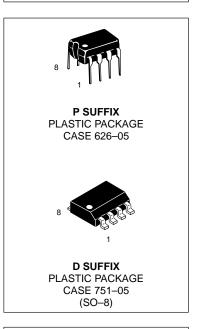
- Matched Propagation Delay for Both Channels
- Low Side Output In Phase with RT

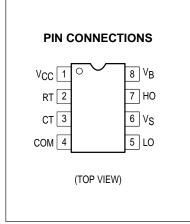
PRODUCT SUMMARY

 $\begin{array}{lll} \text{VOFFSET} & 600 \text{ V MAX} \\ \text{Duty Cycle} & 50\% \\ \\ \text{VOUT} & 10-20 \text{ V} \\ \\ \text{t}_{\textit{r/f}} \text{ (typical)} & 120 \text{ & 60 ns} \\ \\ \text{Deadtime (typical)} & 1.2 \text{ } \mu\text{s} \\ \end{array}$

MPIC2151

SELF-OSCILLATING HALF-BRIDGE DRIVER



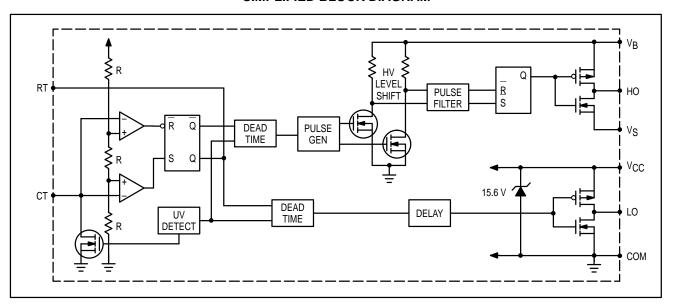


ORDERING INFORMATION

Device	Package
MPIC2151D	SOIC
MPIC2151P	PDIP

This document contains information on a new product. Specifications and information herein are subject to change without notice.

SIMPLIFIED BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Rating		Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage High Side Floating Supply Offset Voltage High Side Floating Output Voltage Low Side Output Voltage RT Voltage CT Voltage		VB VS VHO VLO VRT VCT	-0.3 V _B -25 V _S -0.3 -0.3 -0.3	625 VB+0.3 VB+0.3 VCC+0.3 VCC+0.3 VCC+0.3	VDC
Supply Current (Note 1) High Side Output Current Low Side Output Current RT Output Current		ICC IHO ILO IRT	- -500 -500 -5.0	25 500 500 5.0	mA _{DC}
Allowable Offset Supply Voltage Transient		dV _S /dt	-	50	V/ns
*Package Power Dissipation @ T _C ≤ +25°C	(8 Lead DIP) (8 Lead SOIC)	P _D -	- -	1.0 0.625	Watt
Operating and Storage Temperature		T _j , T _{stg}	-55	150	°C
Thermal Resistance, Junction to Ambient	(8 Lead DIP) (8 Lead SOIC)	$R_{ heta JA}$	_ _	125 200	°C/W
Lead Temperature for Soldering Purposes, 10 se	conds	TL	-	260	°C

RECOMMENDED OPERATING CONDITIONS

The Input/Output logic timing Diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions.

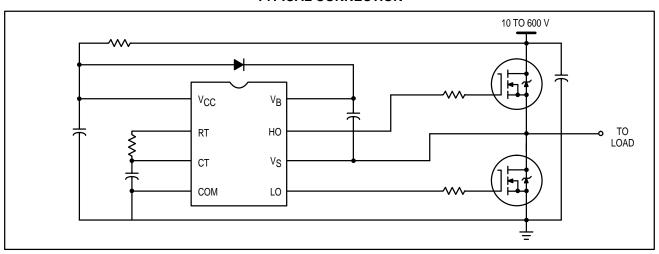
High Side Floating Supply Absolute Voltage	V _B	V _S +10	Vs+V _{clamp}	V
High Side Floating Supply Offset Voltage	٧S	-	600	
High Side Floating Output Voltage	VHO	٧s	VB	
Low Side Output Voltage	V _{LO}	0	Vcc	
Supply Current (Note 1)	ICC	-	5.0	mA
Ambient Temperature	TA	-40	125	°C

Note 1: Because the MPIC2151 is designed specifically for off–line supply systems, this IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6 V. Therefore, the IC supply voltage is normally derived by forcing current into the supply lead (typically by means of a high value resistor connected between the chip V_{CC} and the rectified line voltage and a local decoupling capacitor from V_{CC} to COM) and allowing the internal zener clamp circuit to determine the nominal supply voltage. Therefore, this circuit should not be driven by a DC, low impedance power source of greater than V_{CLAMP}.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise specified)

Characteristic	Symbol	Min	Тур	Max	Unit
STATIC ELECTRICAL CHARACTERISTICS					
Supply Characteristics $V_{BIAS} \ (V_{CC}, V_{BS}) = 12 \ V, \ V_{SS} = COM \ and \ C_L = 1000 \ pF \ unless \ otherwise$	specified.				
V _{CC} Supply Undervoltage Positive Going Threshold	VCCUV+	-	8.4	_	VDC
V _{CC} Supply Undervoltage Negative Going Threshold	VCCUV-	-	8.0	_	1
Quiescent V _{CC} Supply Current	IQCC	_	400	-	μА
V _{CC} Zener Shunt Clamp Voltage @ I _{OC} = 5 mA	VCLAMP	-	15.6	-	VDC
Floating Supply Characteristics					
Offset Supply Leakage Current @ V _B = V _S = 600 V	ILK	_	_	50	μADC
Quiescent V _{BS} Supply Current	IQBS	-	10	_	1
Oscillator I/O Characteristics	<u> </u>		•		•
Oscillator Frequency @ RT = 35.7 K Ω , CT = 1 nF	fosc	-	20	_	kHz
Oscillator Frequency @ RT = 7.04 KΩ, CT = 1 nF	fosc	_	100	-	1
CT Input Current	lСТ	-	0.001	1.0	μА
CT Undervoltage Lockout @ 2.5 V < V _{CC} < V _{CCUV+}	VCTUV	-	0	-	mV
RT High Level Output Voltage, V_{CC} – RT @ IRT = -100 μ A @ IRT = -1 mA	V _{RT+} V _{RT+}	_	20 200	_ _	
RT Low Level Output Voltage, V _{CC} + RT @ IRT = 100 μA @ IRT = 1 mA	V _{RT} - V _{RT} -	_	20 200		
RT Undervoltage Lockout, V _{CC} – RT @ 2.5 V < V _{CC} < V _{CCUV+}	V _{RTUV}	-	0	-	1
2/3 V _{CC} Threshold	V _{CT+}	-	8.0	-	VDC
1/3 V _{CC} Threshold	V _{CT} -	-	4.0	-	1
Output Characteristics			•	•	•
High Level Output Voltage, V _{BIAS} -V _O @ I _O = 0 A	Voн	-	_	100	mV
Low Level Output Voltage, V _O @ I _O = 0 A	VOL	-	-	100	1
Dynamic Electrical Characteristics V _{BIAS} (V _{CC} , V _{BS}) = 12 V and C _L = 1000 pF unless otherwise specified. T _A	= 25°C.			•	
Turn-On Rise Time	t _r	-	120	_	ns
Turn-Off Fall Time	t _f	-	60	-	1
Deadtime, LS Turn-Off to HS Turn-On & HS Turn-Off to LS Turn-On	DT	_	1.2	_	μА
RT Duty Cycle, f _{OSC} = 20 kHz	DC	_	50	_	%

TYPICAL CONNECTION



LEAD DEFINITIONS

Symbol	Lead Description
RT	Oscillator timing resistor input; a resistor is connected from RT to CT. RT is in phase with LO for normal IC operation.
СТ	Oscillator timing capacitor input; a capacitor is connected from CT to COM in order to program the oscillator frequency according to the following equation: $f = \frac{1}{1.4 \; (\text{RT} + 75\Omega) \; \text{CT}}$ where 75 Ω is the effective impedance of the RT output stage.
V _B	High Side Floating Supply
НО	High Side Gate Drive Output
٧s	High Side Floating Supply Return
Vcc	Logic and Low Side Fixed Supply
LO	Low Side Gate Drive Output
COM	Logic and Low Side Return

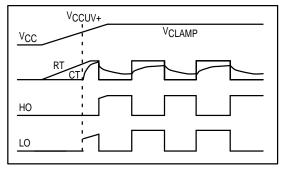


Figure 1. Input / Output Timing Diagram

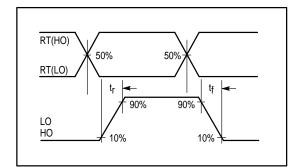


Figure 2. Switching Time Waveform Definitions

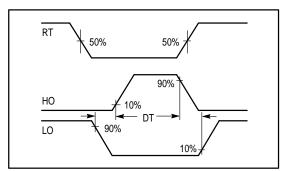
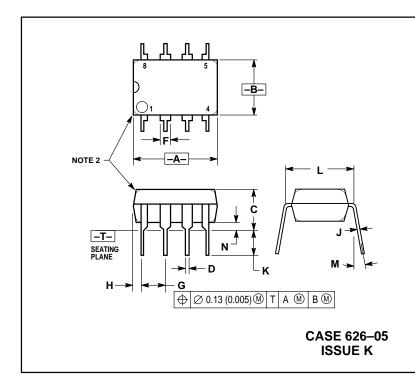


Figure 3. Deadtime Waveform Definitions

PACKAGE DIMENSIONS



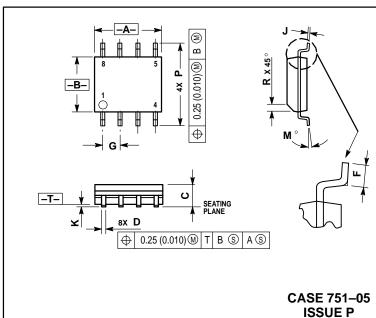
- NOTES:

 1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

 2. PACKAGE CONTOUR OPTIONAL (ROUND OR SOUARE CORNERS).

 3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.40	10.16	0.370	0.400
В	6.10	6.60	0.240	0.260
С	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54	BSC	0.100) BSC
Н	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62	BSC	0.300 BSC	
M		10°		10°
N	0.76	1.01	0.030	0.040
STYLE 1: PIN 1. AC IN 2. DC + IN 3. DC - IN 4. AC IN 5. GROUND 6. OUTPUT 7. AUXILIARY 8. VCC				



- NOTES:

 1. DIMENSIONS A AND B ARE DATUMS AND T IS A DATUM SURFACE.
 2. DIMENSIONING AND TOLERANCING PER ANSI

- 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 3. DIMENSIONS ARE IN MILLIMETER.
 4. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 6. DIMENSION D DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS			
DIM	MIN	MAX		
Α	4.80	5.00		
В	3.80	4.00		
С	1.35	1.75		
D	0.35	0.49		
F	0.40	1.25		
G	1.27	1.27 BSC		
J	0.18	0.25		
K	0.10	0.25		
M	0°	7°		
Р	5.80	6.20		
R	0.25	0.50		

MPIC2151

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